Version: B

2025-02-26

# Specification for Approval

Customer:	
Model Name:	

Sı	Customer approval		
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		

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## **Revision Record**

REV NO.	REV DATE	CONTENTS	Note
Α	2025-02-10	NEW ISSUE	
В	2025-02-17	MODIFY OUTLINE & BRIGHTNESS	

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#### 1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution.

#### 2. General Information

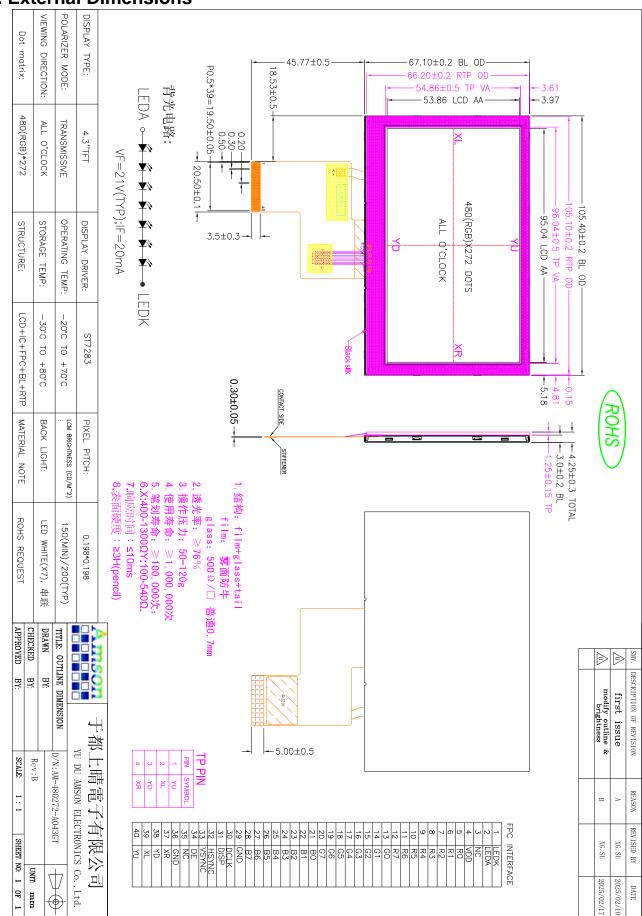
ITEM	STANDARD VALUES	UNITS
LCD type	4.3"TFT	
Dot arrangement	480(RGB)×272	dots
Color filter array	RGB vertical stripe	
Display mode	IPS/ Transmission / Normally BALCK	-
Gray Scale Inversion Direction	85/85/85	
Eyes Viewing Direction	ALL	
Driver IC	ST7283	
Module size	105.40(W)×67.10(H)×4.25(T)	mm
Active area	95.04(W)×53.86(H)	mm
Interface	24bit RGB	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	7 White LED	



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#### 3. External Dimensions





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4. Interface Description

Pin	Symbol	Description.
1	LEDK	LED backlight (Cathode).
2	LEDA	LED backlight (Anode).
3	NC	No connection.
4	VDD	Power supply.
5~12	R0~R7	Red Data.
13~20	G0~G7	Green Data.
21~28	B0~B7	Blue Data.
29	GND	Ground.
30	DCLK	Clock.
31	DISP	Display on/off.
32	HSYNC	Horizontal sync input in RGB mode.
33	VSYNC	Vertical sync input in RGB mode.
34	DE	Data input Enable.
35	NC	No connection.
36	GND	Ground.
37	XR	TP Right.
38	YD	TP Bottom.
39	XL	TP Left.
40	YU	TP Up.



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5. Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Remark
Power Voltage	VCC	0.3	3.6	V	
Input Voltage	VIN	-0.3	3.6	V	Note1、Note2
Operating temperature	TOPR	-20	70	°C	
Storage temperature	TSTR	-30	80	°C	
Humidity			90	%RH	

#### Remark:

Note 1) The driver IC may be permanently damaged if it is used under the condition exceeding the above absolute maximum values. It is also recommended to use the driver IC within the limit of its electric characteristics during normal operation. Exceeding the conditions may lead to malfunction of it and affect its credibility.

Note 2) The voltage from VSS

#### 6. DC Characteristics

Ham		Comple ed		l lm:t	Domosik		
Item		Symbol	Min	Тур	Max	Unit	Remark
Power Voltage	Logic	VCC	3.0	3.3	3.6	V	
Innut Valtage	L level	VIL	GND		0.3*VCC	V	VCC=
Input Voltage	H level	VIH	0.7* VCC		VCC	V	3.0~ 3.6V

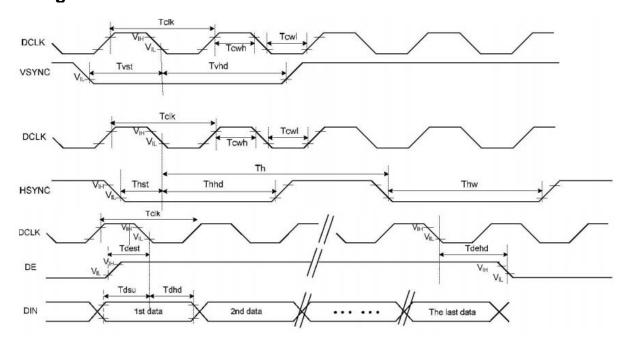
#### Remark:

Note1: Vcom must be adjusted to optimize display quality: Cross-talk, Contrast Ratio and etc.

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#### 7. Timing Characteristics



I	tem	Symbol	Min.	Тур.	Max.	Unit	Remark
DCLK I	Frequency	Felk	8	9	12	MHz	
DCLE	K Period	Telk	83	111	125	ns	
Fran	ne Pate	FR			75	Hz	
Line	Period	Tlp	24			us	
	Period Time	Th		531		DCLK	
	Display Period	Thdisp		480		DCLK	
HSYNC	Back Porch	Thbp		43		DCLK	By H_Blanking setting
	Front Porch	Thfp		8		DCLK	
	Pulse Width	Thw		4		DCLK	
	Period Time	Tv		292		Н	
	Display Period	Tvdisp		272		Н	
VSYNC	Back Porch	Tvbp		12		Н	By V_Blanking setting
	Front Porch	Tvfp		8		Н	
	Pulse Width	Tvw		4		Н	

#### Note:

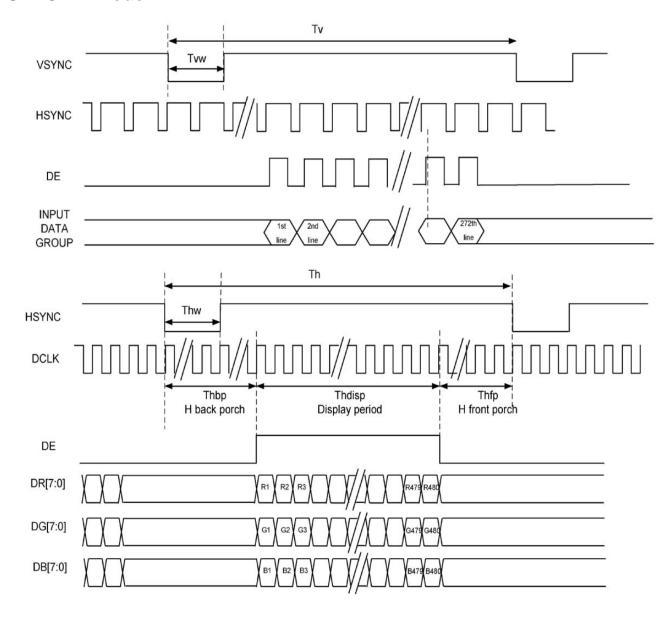
- 1. It is necessary to keep Tvbp =12, Tvfp = 8, Tvw = 4 and Thbp = 43, Thfp = 8 Thw = 4 in sync mode.
- 2. The Max Value and Min Value of porch must satisfy the range of Frame Pate and Line Period
- 3. It is necessary to keep Thbp>10, Tvbp+Tvfp<128



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#### **SYNC-DE Mode**



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### 8. Backlight Characteristics

背光电路:

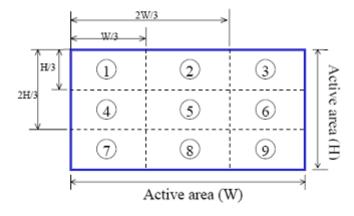


$$VF=21V(TYP);IF=20mA$$

Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	19.6	21.0	23.6	V	If=20mA
Supply Current	If	-	20	-	mA	-
Luminous Intensity for LCM	-	150	200	-	cd/m <sup>2</sup>	If=20mA
Uniformity for LCM	-	80	-	-	%	If=20mA
Backlight Color	White					

#### ★1 Uniform measure condition:

- (1)Measure 9 point. Measure location is show below:
- (2)Uniform = (Min. brightness / Max. brightness)×100%
- (3)Best Contrast.





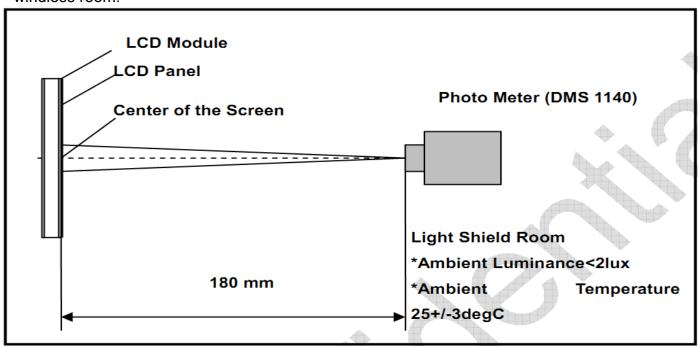
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9. Optical Characteristics

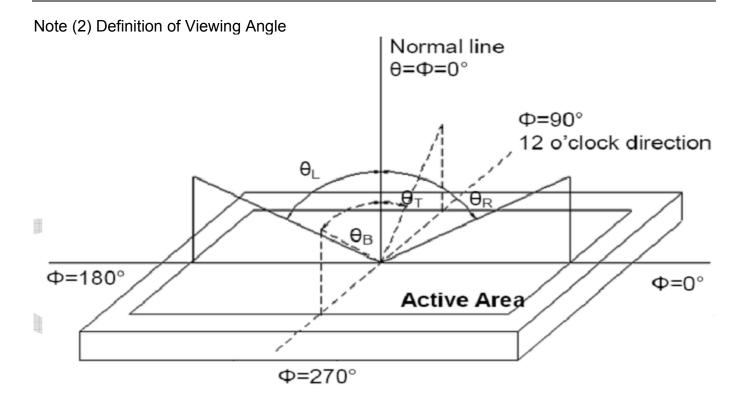
Item	Condition	S	Min.	Тур.	Max.	Unit	Note	
	Horizontal	θL	80	85	-			
Viewing Angle	HOHZOHIAI	θR	80	85	-	dograa	(1) (2) (6)	
(CR>10)	Vertical	θт	80	85	-	degree	(1),(2),(6)	
	vertical	θв	80	85	_			
Contrast Ratio	Center		800	1000	-	-	(1),(3),(6)	
Response Time	$T_r + T_f$		-	30	35	ms	(1),(4),(6)	
	Red x			0.603		-		
	Red y			0.307		-		
	Green x			0.314		-		
CF Color	Green y			0.557		-	(1) (6)	
	Chromaticity (CIE1931) Blue x		Тур.	0.145	Тур.	-	(1), (6)	
			-0.05	0.153	+0.05	-		
	White x			0.305		-		
	White y			0.336		-		

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



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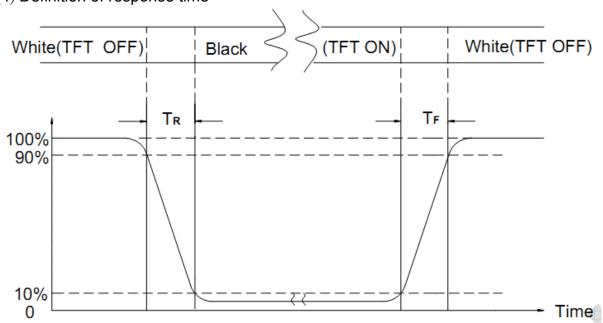


Note (3) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input)

Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD



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10. Reliability Test Conditions and Methods

10. Renability	103t Odificitions and Mctifods			
ITEM	CONDITIONS	CRITERION		
OPERATING TEMPERATUR	HIGH TEMPERTURE +70°C 48HRS	NO DEFECT IN DISPLAYING AND		
E	LOW TEMPERTURE -20°C 48HRS	OPERATIONAL FUNCTION		
STORAGE TEMPERATUR	HIGH TEMPERTURE +80°C 48HRS	NO DEFECT IN DISPLAYING AND		
E	LOW TEMPERTURE -30°C 48HRS	OPERATIONAL FUNCTION		
HUMIDITY	40°C 90%RH 48HRS	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION		

Note: The need to restore at room temperature for 2 hours after the test.

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#### 11. Inspection Standard

1. AQL (Acceptable Quality Level)

AQL of major and minor defect

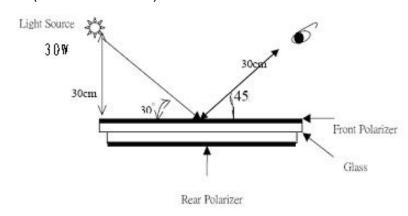
According to GB/T 2828-2003;, normal inspection, Class II

MAJOR DEFECT	MINORDEFECT
0.65	1.5

#### 2. Basic conditions for inspection

The LCM face to us, in normal environment, About an angle of incidence 30, a distance of 30cm with normal eye, with an angle of 45 degree to check the products without uncovering the film!

(As shown below)



- Inspection item and criteria
- 3.1 Visual inspection criterion in immobility

#### 3.1.1 Glass defect

No	Defect item	Criteria	Remark
1	Dimension Unconformity	By Engineering Drawing	
	(Major defect)		



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No	Defect item	Criteria	Remark
2	Cracks (Major defect)	1.Linear cracks on panel	
3	Glass extrude the conductive area (minor defect)	a: disregards and no influence assemblage 1) b≤1/3Pin width(non bonding area)  [Accept] 2) bonding area≤0.5mm [Accept]	a:Length, b:Width
4	Pin-side , conductive area damaged (minor defect)	<ul><li>(a c : disregards)</li><li>b≤ 1/3 of effective length for bonding electrode</li><li>[Accept]</li></ul>	a:Length, b:Width, c:Thickness
5	Pin-side · non-conductive area damaged (minor defect)	1) Damage area don't touch the ITO (Inclueling contraposition mark,except scribing mark)	a:Length, b:Width, c:Thickness



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No	Defect item	Criteria		Remark
	Non-pin-side damage	c <t< td=""><td></td><td>c : Thickness b: width of</td></t<>		c : Thickness b: width of
		1) b exceeds 1/3 BM		damage
	(minor defect)			
6			[Reject]	BM内级
		c=T		
		b not touch the seal glue		
			[Reject]	

3.1.2 LCD appearance defect (View area)

	. 1.2 LOD appearance defect (view area)						
No	Defect item	Criteria		Remark			
	Fiber · glass	Specification	Allowable	note1: L:Length,W:Width			
1	cratch · polarizer	0.05mm <w≦0.1mm;< td=""><td>1</td><td>note2: disregard if out of AA</td></w≦0.1mm;<>	1	note2: disregard if out of AA			
'	scratch/folded	L≦3.0mm	1	L →			
	(minor defect)	W>0.1mm ; L>3.0mm	0				
	Polarizer bubble \	ψ≦0.2mm	disregard	note 1:ψ=(L+W)/2; Length , W:			
2	concave and convex (minor defect)	0.2mm<ψ ≦ 0.3mm	2	Width note2: disregard if out of AA			
-	(minor defect)	0.3mm<ψ ≦ 0.5mm	1	notez: disregald il out of AA			
		0.5mm<ψ	0				
	Diagla data distributata	ψ≦0.15mm	disregard	note2: disregard if out of AA			
3	Black dots · dirty dots · impurities · eyewinker	0.15mm<ψ ≦ 0.25mm	2	$\bigcirc \qquad \boxed{\downarrow} \ \phi$			
3		0.25mm<ψ ≦ 0.3mm	1	<b>←→</b>			
	(Major defect)	0.3mm<ψ	0	ψ			
	Polarizer prick	ψ≦0.1mm	disregard	note1:ψ=(L+W)/2 ;L= Length,			
4	(Major defect)	0.1mm<ψ≦0.25mm	3	W=Width note2: the distance between two			
		ψ>0.25mm	0	dots >5mm			



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#### 3.1.3 .FPC

No	Defect item	Criteria		Remark
1	Copper screen peel (Major defect)	Copper screen peel	[Reject]	
2	No release tape or peel (Major defect)	No release tape or peel	[Reject]	
	Dirty dot and impurity of	Specification	Allowable	note1: Cannot have stride ITO
3	FPC for customer using	ψ≦0.25mm	2	impurities
	side (minor defect)	ψ>0.25	0	

3.1.4 Black tape & Mara tape

<u> </u>	.4 Black tape & Mara tape			
	FPC or H/S black tape	1.shift spec:		
	shift	1)glue to the polarize		
			[Reject]	
1		2) IC bare	[Reject]	
'	(minor defect)	2. left-and-right spec:		
		1) exceed of FPC edge	or H-S	1
		edge	[Reject]	
		2)IC bare	[Reject]	
2	No black tape	No black tape		
	(Major defect)		[Reject]	
3	Tape position mistake	Not by engineering draw	/ing	
<u> </u>	(minor defect)		[Reject]	
4	Mara tape defect	Peel before pulling the	protecting	
		film.		
	(minor defect)		[Reject]	

3.1.5 Silicon and Tuffy glue

No	Defect item	Criteria		Rem	nark	
	Quantity of silicon	Uncover the ITO and circuit area.	note:	compared	by	engineering
	(minor defect)		ect] drawing.			
1						



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No	Defect item	Criteria	Remark
2	Tuffy glue (minor defect)	<ol> <li>Uncover the reveal copper area [Reject]</li> <li>Cover layer 0.3mm(Min) ~ 3.0mm(Max) [accept]</li> </ol>	requirement , refer to the
3	Depth of glue covering (minor defect)	' ' ' ' ' '	Except of the special requirement

#### 3.2 Electrical criteria

5.2	Electrical criteria		
No	Defect item	Criteria	Remark
1	No display	No display	
Ľ	(Major defect)	[Reject]	
2	Missing line	Missing line	
	(Major defect)	[Reject]	
3	Seg-com light and dark	Seg-com light and dark	ND filter 2% test
	(Major defect)	[Reject]	
4	No display in immobility	No display in immobility	
_	(Major defect)	[Reject]	
5	Flicker of Pattern	Flicker of Pattern	
	(Major defect)	[Reject]	
6	Mura (Major defect)	ND filter 2% test	
7	Over current	Over current	
	(Major defect)	[Reject]	
	Voltage out of specification	Voltage out of specification	
8		[Reject]	
	(Major defect)		
	Pattern blur ,error code	Pattern blur ,error code	
9		[Reject]	
	(Major defect)		
	Dark light, Flicker	Dark light, Flicker	
10	(Major defect)	[Reject]	



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No	Defect item	Criteria		Remark
	Black/White dots	Specification	Allowable	Note1: disregard if out of
	、Dirty dots 、eyewinker	ψ≦0.15mm	disregard	]AA 
11	/Maiou dofo a4)	$0.15$ mm< $\psi \le 0.25$ mm	2	$\phi$
	(Major defect)	$0.25$ mm< $\psi \le 0.3$ mm	1	$\phi$
		0.3mm<ψ	0	,
	Fiber · glass cratch ·	W≦0.03mm	disregard	note1: L: Length , W: Width
	polarizer scratch/folded	0.03mm <w≦0.05mm; L≦3.0mm</w≦0.05mm; 	2	note2: disregard if out of AA
12	(minor defect)	0.05mm <w≦0.1mm; L≦3.0mm</w≦0.1mm; 	1	
		W>0.1mm ; L>3.0mm	0	"



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### 12. Handling Precautions

#### 12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

#### 12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Sulfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

#### 12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to VDD or GND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

#### 12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

#### 12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
  - Usage under the maximum operating temperature, 50%Rh or less is required.



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#### 12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
   [It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

#### 12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

#### 13. Precaution for Use

#### 13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

#### 13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification.
- When a new problem is arisen this is not specified in this specification.
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT and some problem is arisen in this specification due to the change.
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

## 14. Packing Method TBD